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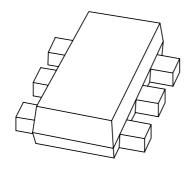
If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

## **DISCRETE SEMICONDUCTORS**

# DATA SHEET



# **PMEG1020EV**Ultra low V<sub>F</sub> MEGA Schottky barrier rectifier

Product data sheet 2003 Jul 15



## Ultra low V<sub>F</sub> MEGA Schottky barrier rectifier

## PMEG1020EV

#### **FEATURES**

Forward current: 2 AReverse voltage: 10 VUltra low forward voltage

· Ultra small plastic SMD package.

#### **APPLICATIONS**

• Low voltage rectification

• High efficiency DC/DC conversion

• Switch mode power supply

· Inverse polarity protection

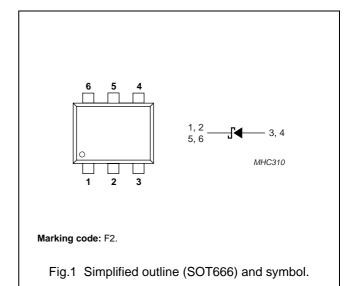
· Low power consumption applications.

#### **DESCRIPTION**

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection encapsulated in a SOT666 ultra small plastic SMD package.

#### **PINNING**

PIN	DESCRIPTION
1	cathode
2	cathode
3	anode
4	anode
5	cathode
6	cathode



#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>R</sub>	continuous reverse voltage		_	10	V
I <sub>F</sub>	continuous forward current	T <sub>sp</sub> ≤ 55 °C; note 1	_	2	Α
I <sub>FRM</sub>	repetitive peak forward current	$t_p \le$ 1 ms; $\delta \le$ 0.5; note 1	_	3.2	Α
I <sub>FSM</sub>	non-repetitive peak forward current	t <sub>p</sub> = 8 ms square wave; note 1	_	9	Α
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

#### Note

1. Only valid if pins 3 and 4 are connected in parallel.

## Ultra low V<sub>F</sub> MEGA Schottky barrier rectifier

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#### **ELECTRICAL CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V <sub>F</sub>	forward voltage	orward voltage see Fig.2; note 1			
		I <sub>F</sub> = 0.01 A	100	130	mV
		I <sub>F</sub> = 0.1 A	164	200	mV
		I <sub>F</sub> = 1 A	255	350	mV
		I <sub>F</sub> = 2 A	306	460	mV
I <sub>R</sub>	reverse current	see Fig.3 note 2			
		V <sub>R</sub> = 5 V	0.7	2	mA
		V <sub>R</sub> = 8 V	1	2.5	mA
		V <sub>R</sub> = 10 V	1.2	3	mA
$C_d$	diode capacitance	$V_R = 5 \text{ V}$ ; $f = 1 \text{ MHz}$ ; see Fig.4	37	45	pF

#### **Notes**

- 1. Pulse test:  $t_p = 300 \ \mu s$ ;  $\delta = 0.02$ .
- For Schottky barrier rectifiers thermal runaway has to be considered, as in some applications the reverse power losses (P<sub>R</sub>) are a significant part of the total power losses.

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	405	K/W
		note 2	215	K/W
R <sub>th j-s</sub>	thermal resistance from junction to solder point	note 3	80	K/W

#### **Notes**

- 1. Refer to SOT666 standard mounting conditions.
- 2. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for cathode 1 cm<sup>2</sup>.
- 3. Solder point of cathode tabs.

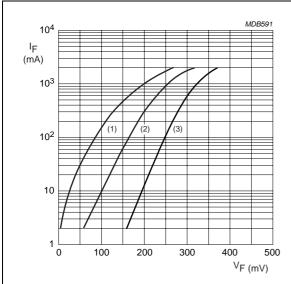
#### Soldering

Reflow soldering is the only recommended soldering method.

# Ultra low V<sub>F</sub> MEGA Schottky barrier rectifier

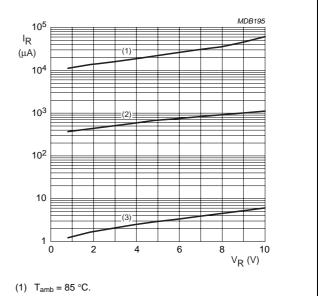
## PMEG1020EV

#### **GRAPHICAL DATA**



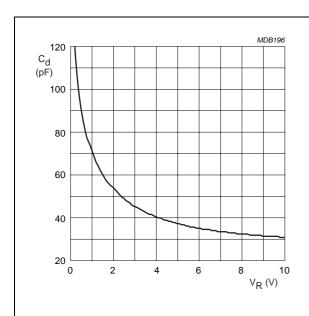
- (1)  $T_{amb} = 85 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig.2 Forward current as a function of forward voltage; typical values.



- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig.3 Reverse current as a function of reverse voltage; typical values.



 $f = 1 \text{ MHz}; T_{amb} = 25 \,^{\circ}\text{C}.$ 

Fig.4 Diode capacitance as a function of reverse voltage; typical values.

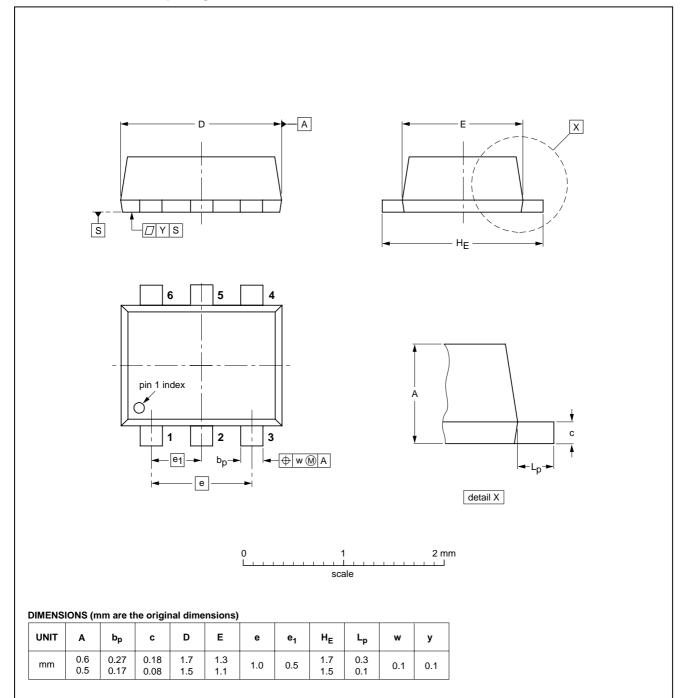
# Ultra low V<sub>F</sub> MEGA Schottky barrier rectifier

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#### **PACKAGE OUTLINE**

Plastic surface mounted package; 6 leads

SOT666



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE
SOT666						<del>01-01-04</del> 01-08-27

## Ultra low V<sub>F</sub> MEGA Schottky barrier rectifier

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#### **DATA SHEET STATUS**

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

#### **Notes**

- 1. Please consult the most recently issued document before initiating or completing a design.
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#### **Contact information**

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For sales offices addresses send e-mail to: salesaddresses@nxp.com

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